

PECVD1 SIN 1000A, Thickness uniformity																
Date		1/6/2014			1/23/2014			2/3/2014			2/18/2014			3/14/2014		
4"Si wafer	Position	JAW EC-400			JAW EC-400			JAW EC-400			JAW EC-400			JAW EC-400		
		Thickness (Å)	n(632.8)	n(1550)	Thickness (Å)	n(632.8)	n(1550)	Thickness (Å)	n(632.8)	n(1550)	Thickness (Å)	n(632.8)	n(1550)	Thickness (Å)	n(632.8)	n(1550)
Wafer-up																
4cm up from the center of wafer	9	1020.11	1.950	1.899	1098.46	1.937	1.892	1039.25	1.940	1.893	1028.13	1.935	1.889	1029.08	1.934	1.887
Center of wafer	5	1055.25	1.949	1.899	1133.40	1.935	1.890	1046.60	1.937	1.893	1030.66	1.935	1.890	1042.16	1.933	1.887
Major cut-down																

